



FORSEMI

FS2244

150V N-Channel MOSFET

● Features

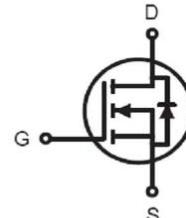
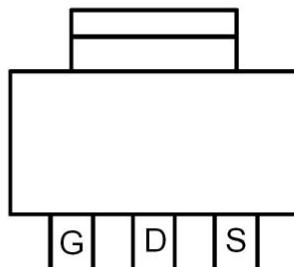
150V/2.8A ,
 $R_{DS(ON)} < 300\text{m}\Omega$ @ $V_{GS} = 10\text{V}$
Lead Free Available (RoHS Compliant)

● General Description

The FS2244 combines advanced trench MOSFET technology with a low resistance package to provide extremely low $R_{DS(ON)}$. this device is well suited for high current load applications.

● Pin Configuration

SOT223



SOT223

● Absolute Maximum Ratings $T_A=25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Maximum	Units
Drain-Source Voltage	V_{DS}	150	V
Gate-Source Voltage	V_{GS}	± 20	
Continuous Drain Current($T_J=150^\circ\text{C}$) ^a	I_D	2.8	A
		2.5	
Pulsed Drain Current ^b	I_{DM}	12	
Avalanche Current ^b	I_{AS}	15	
Avalanche energy	E_{AS}	15	mJ
Power Dissipation ^a	P_D	0.75	W
		0.5	
Junction and Storage Temperature Range	T_J, T_{STG}	-55 to 150	°C

Notes

- a. Surface Mounted on 1x1FR4 Board.
- b. Pulse width limited maximum junction temperature



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● Electrical Characteristics ($T_A=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
STATIC PARAMETERS						
BV_{DSS}	Drain-Source Breakdown Voltage	$I_D=1\text{mA}, V_{GS}=0\text{V}$	150			V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=100\text{V}, V_{GS}=0$	$T_A=25^\circ\text{C}$		1	uA
			$T_A=70^\circ\text{C}$		60	
I_{GSS}	Gate-Body leakage current	$V_{DS}=0\text{V}, V_{GS}=\pm 20\text{V}$			± 0.1	
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	2		4	V
$I_{D(\text{ON})}$	On state drain current ^a	$V_{GS}=10\text{V}, V_{DS}\geqslant 15\text{V}$	10.8			A
$R_{DS(\text{ON})}$	Static Drain-Source On-Resistance ^a	$V_{GS}=10\text{V}, I_D=10\text{A}$		260	300	mΩ
		$V_{GS}=6\text{V}, I_D=10\text{A}$			320	
g_{FS}	Forward Trans conductance ^a	$V_{DS}=15\text{V}, I_D=10\text{A}$		6.5		S
V_{SD}	Diode Forward Voltage	$I_S=10\text{A}, V_{GS}=0\text{V}$	0.3		1.2	V
I_S	Maximum Body-Diode Continuous Current				1.2	A
Dynamic^b						
Q_g	Total Gate Charge	$V_{GS}=10\text{V}, V_{DS}=50\text{V}, I_D=3\text{A}$		3.2		nC
Q_{gs}	Gate - Source Charge			0.45		
Q_{gd}	Gate - Drain Charge			1.6		
R_g	Gate resistance		0.5		2.5	Ω
Switching						
$t_{D(\text{on})}$	Turn-On Delay Time	$V_{GS}=10\text{V}, V_{DS}=50\text{V}, R_L=30\Omega, R_{\text{GEN}}=6\Omega, I_D=0.5\text{A}$		7	12	ns
t_r	Turn-On Rise Time			9.5	17	
$t_{D(\text{off})}$	Turn-Off Delay Time			8	15	
t_f	Turn-Off Fall Time			10	15	
t_{rr}	Body Diode Reverse Recovery Time	$I_F=3\text{A}, dI/dt=100\text{A}/\mu\text{s}$		40	90	

Notes

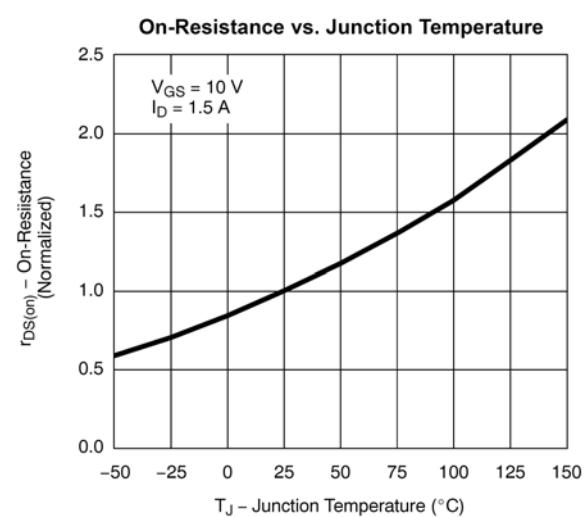
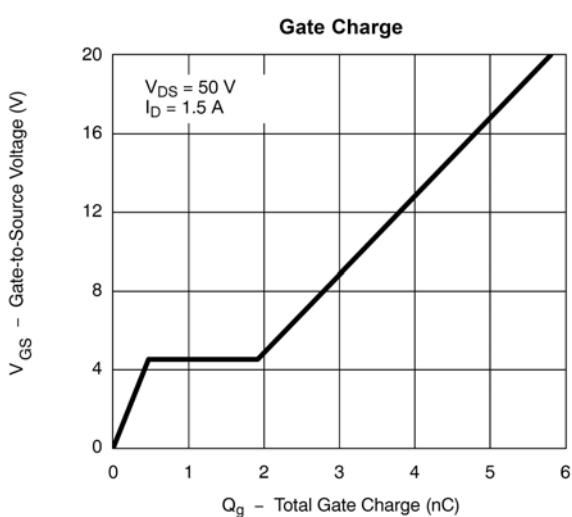
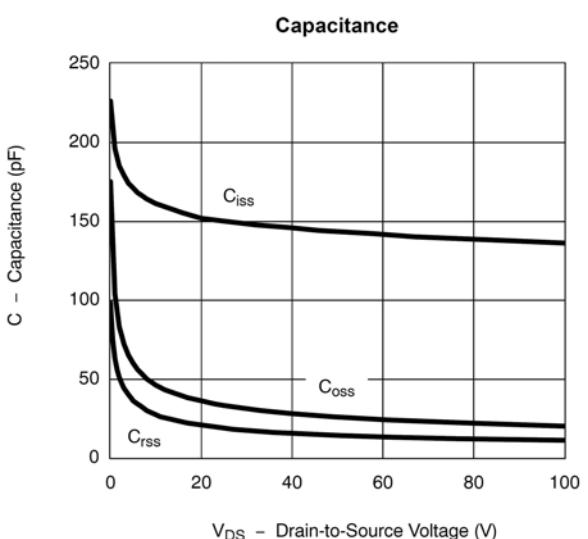
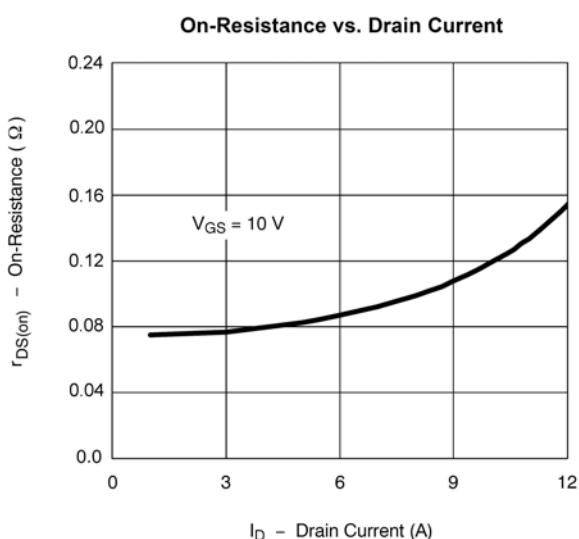
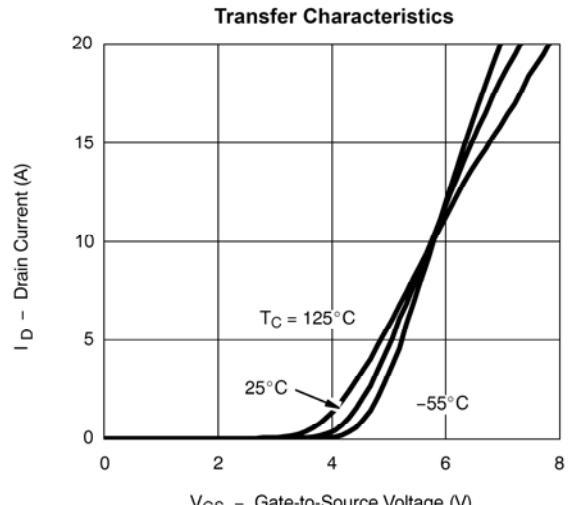
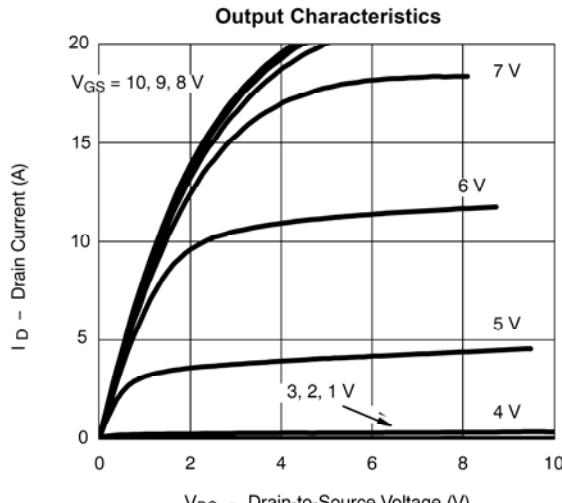
- a. Pulse test: $PW \leqslant 300\text{ }\mu\text{s}$ duty cycle $\leqslant 2\%$
- b. Guaranteed by design, not subject to production testing.



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- TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)





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